



Docket No.: 49657-986

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Takao KAMOSHIMA, et al.

Serial No.: 09/779,565

Filed: February 09, 2001

For: SEMICONDUCTOR DEVICE WITH INTERCONNECTION LAYER

Group Art Unit: 2814

Examiner: T. Le

AMENDMENT

Commissioner for Patents
Washington, DC 20231

Sir:

The following Amendment and Remarks are submitted in response to the Office
Action dated December 11, 2002.

IN THE TITLE:

Please delete the title and insert --SEMICONDUCTOR DEVICE WITH
INTERCONNECTION LAYER--.

IN THE CLAIMS:

Please amend claim 1 as follows.

1. (Amended) A semiconductor device, comprising:
a semiconductor substrate; and

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C. Moore
PATENT